



BCX51T series

45 V, 1 A PNP power bipolar transistors

Rev. 1 — 22 August 2019

Product data sheet

1. Product profile

1.1. General description

PNP power transistors in a medium power SOT89 (SC-62) Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number	Package		NPN complement
	Nexperia	JEDEC	
BCX51T	SOT89	SC-62	BCX54T
BCX51-10T			BCX54-10T
BCX51-16T			BCX54-16T

1.2. Features and benefits

- High collector current capability I_C and I_{CM}
- Three current gain selections
- High power dissipation capability
- AEC-Q101 qualified

1.3. Applications

- Linear voltage regulators
- MOSFET drivers
- High-side switches
- Power management
- Amplifiers

1.4. Quick reference data

Table 2. Quick reference data

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

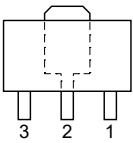
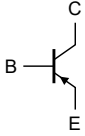
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CEO}	collector-emitter voltage	open base	-	-	-45	V
I_C	collector current		-	-	-1	A
I_{CM}	peak collector current	single pulse; $t_p \leq 1\text{ ms}$	-	-	-2	A

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
h_{FE}	DC current gain						
	BCX51T	$V_{CE} = -2 \text{ V}; I_C = -150 \text{ mA}$	[1]	63	-	250	
	BCX51-10T		[1]	63	-	160	
	BCX51-16T		[1]	100	-	250	

[1] pulsed; $t_p \leq 300 \mu\text{s}$; $\delta \leq 0.02$

2. Pinning information

Table 3. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter		 006aaa231
2	C	collector		
3	B	base		

3. Ordering information

Table 4. Ordering information

Type number	Package		Version
	Name	Description	
BCX51T	SC-62	plastic, surface-mounted package; 3 leads; 1.5 mm pitch; 4.5 mm x 2.5 mm x 1.5 mm body	SOT89
BCX51-10T			
BCX51-16T			

4. Marking

Table 5. Marking

Type number	Marking code
BCX51T	C5
BCX51-10T	C6
BCX51-16T	C7

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter	-	-45	V
V_{CEO}	collector-emitter voltage	open base	-	-45	V
V_{EBO}	emitter-base voltage	open collector	-	-5	V
I_C	collector current		-	-1	A
I_{CM}	peak collector current	single pulse; $t_p \leq 1\text{ ms}$	-	-2	A
I_B	base current		-	-200	mA
I_{BM}	peak base current	single pulse; $t_p \leq 1\text{ ms}$	-	-300	mA
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1]	500	mW
			[2]	800	mW
			[3]	1100	mW
T_j	junction temperature		-	150	°C
T_{amb}	ambient temperature		-55	150	°C
T_{stg}	storage temperature		-65	150	°C

- [1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm².
- [3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm².

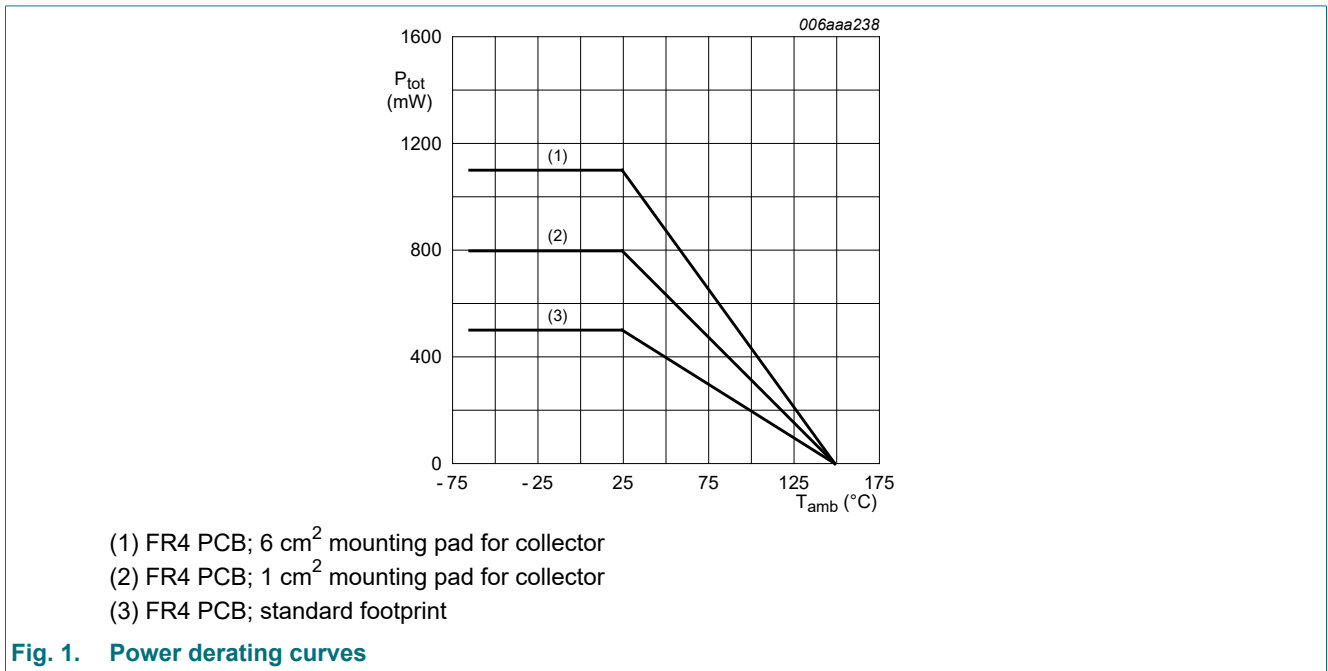


Fig. 1. Power derating curves

6. Thermal characteristics

Table 7. Thermal characteristics

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	250	K/W
			[2]	-	-	157	K/W
			[3]	-	-	114	K/W

- [1] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm^2 .
- [3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm^2 .

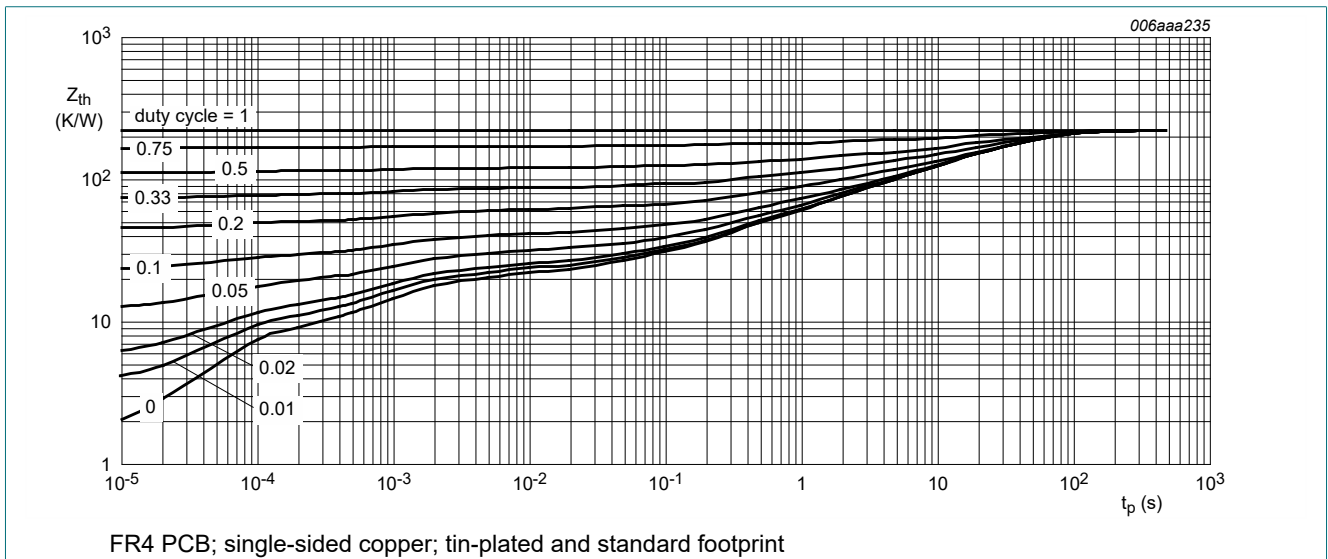


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

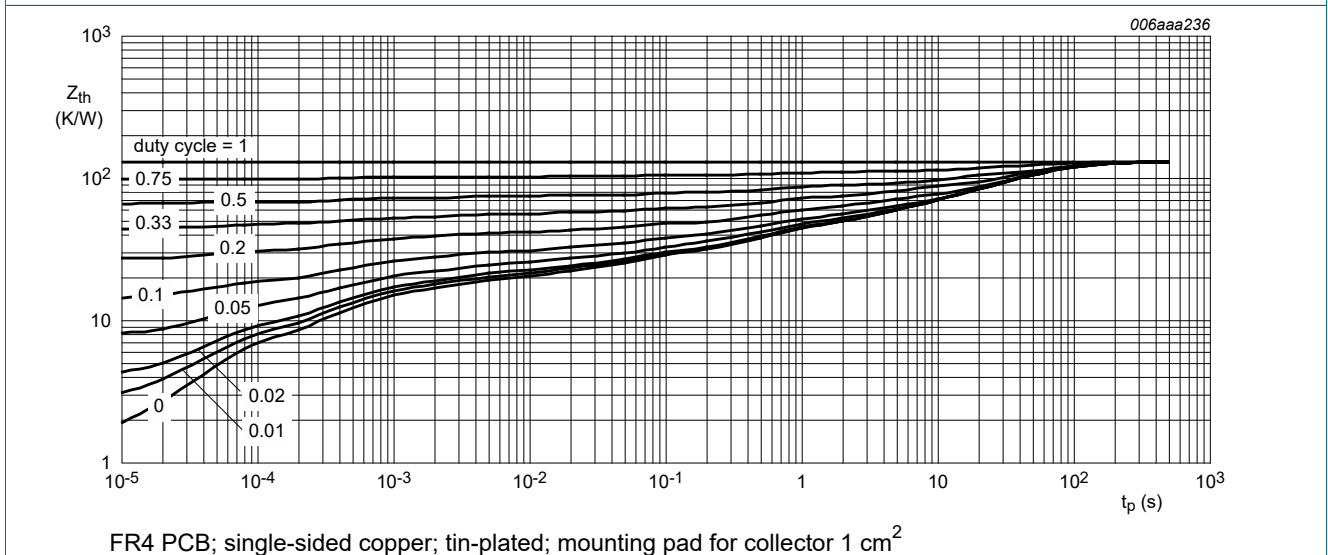
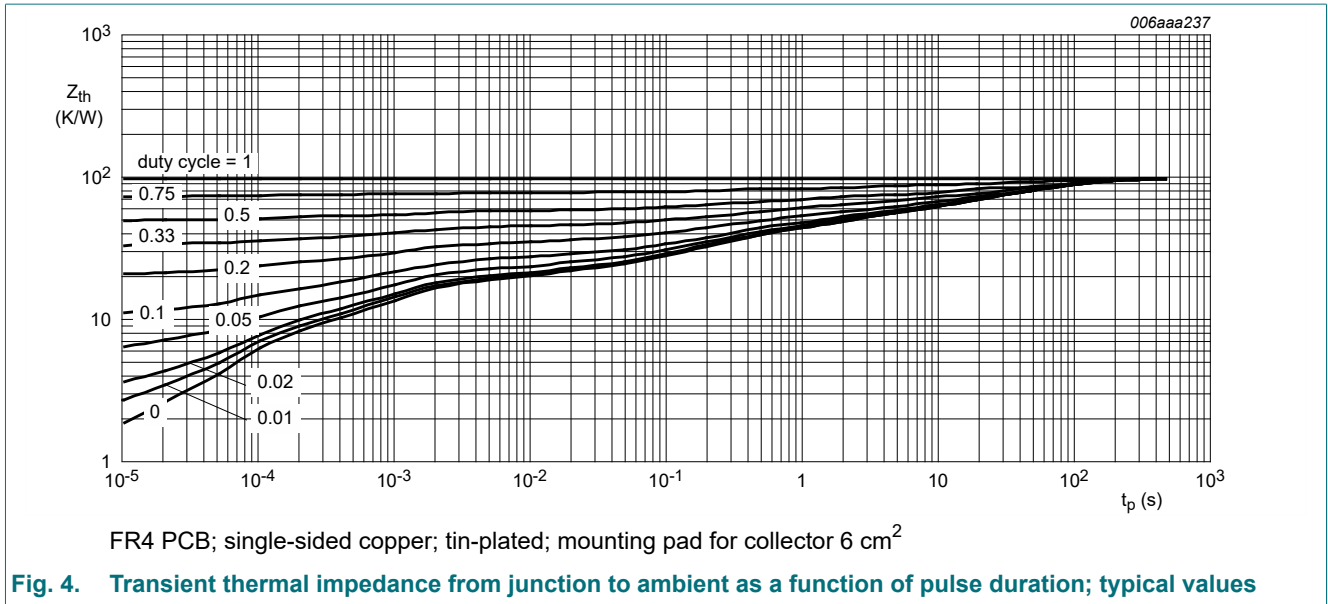


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



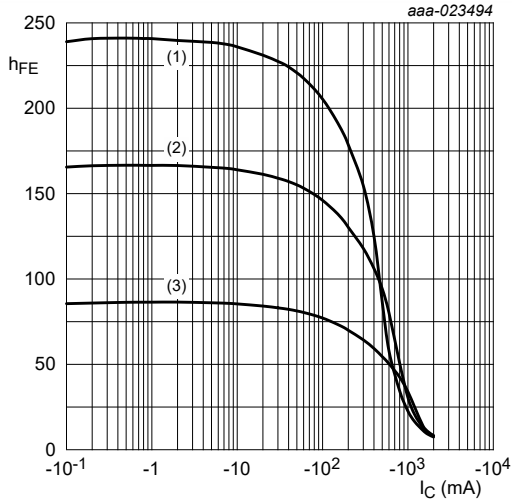
7. Characteristics

Table 8. Characteristics

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

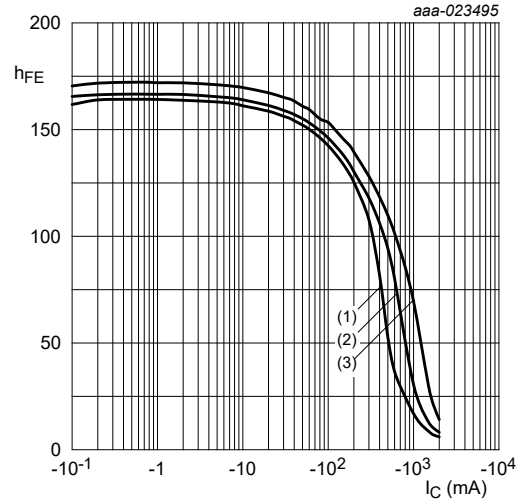
Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = -100\ \mu\text{A}; I_E = 0\ \text{A}$	-45	-		V	
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = -2\ \text{mA}; I_E = 0\ \text{A}$	-45	-		V	
$V_{(BR)EBO}$	emitter-base breakdown voltage	$I_E = -100\ \mu\text{A}; I_C = 0\ \text{A}$	-5	-		V	
I_{CBO}	collector-base cut-off current	$V_{CB} = -30\ \text{V}; I_E = 0\ \text{A}$	-	-	-100	nA	
		$V_{CB} = -30\ \text{V}; I_E = 0\ \text{A}; T_j = 150\text{ °C}$	-	-	-10	μA	
I_{EBO}	emitter-base cut-off current	$V_{EB} = -5\ \text{V}; I_C = 0\ \text{A}$	-	-	-100	nA	
h_{FE}	DC current gain						
	BCX51T, -10T, -16T	$V_{CE} = -2\ \text{V}; I_C = -5\ \text{mA}$		63	-	-	
		$V_{CE} = -2\ \text{V}; I_C = -500\ \text{mA}$	[1]	40	-	-	
	BCX51T	$V_{CE} = -2\ \text{V}; I_C = -150\ \text{mA}$	[1]	63	-	250	
	BCX51-10T	$V_{CE} = -2\ \text{V}; I_C = -150\ \text{mA}$	[1]	63	-	160	
BCX51-16T	$V_{CE} = -2\ \text{V}; I_C = -150\ \text{mA}$	[1]	100	-	250		
V_{CEsat}	collector-emitter saturation voltage	$I_C = -500\ \text{mA}; I_B = -50\ \text{mA}$	[1]	-	-500	mV	
V_{BE}	base-emitter voltage	$V_{CE} = -2\ \text{V}; I_C = -500\ \text{mA}$	[1]	-	-1	V	
f_T	transition frequency	$V_{CE} = -5\ \text{V}; I_C = -50\ \text{mA}; f = 100\ \text{MHz}$	-	140	-	MHz	
C_c	collector capacitance	$V_{CB} = -10\ \text{V}; I_E = I_C = 0\ \text{A}; f = 1\ \text{MHz}$	-	7	-	pF	

[1] pulsed; $t_p \leq 300\ \mu\text{s}; \delta \leq 0.02$



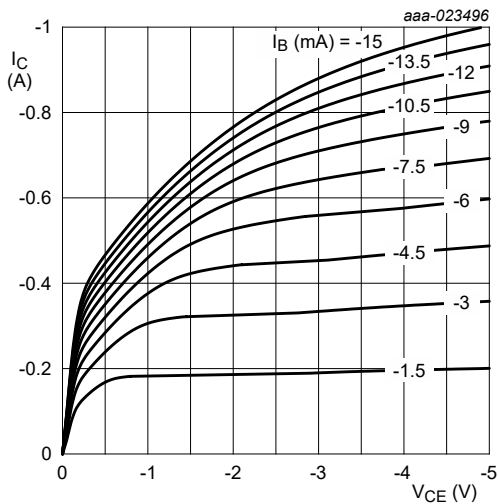
$V_{CE} = -2\text{ V}$
 (1) $T_{amb} = 100\text{ }^\circ\text{C}$
 (2) $T_{amb} = 25\text{ }^\circ\text{C}$
 (3) $T_{amb} = -55\text{ }^\circ\text{C}$

Fig. 5. DC current gain as a function of collector current; typical values



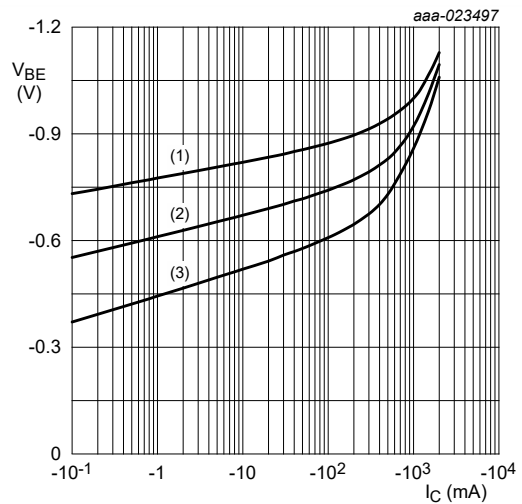
$T_{amb} = 25\text{ }^\circ\text{C}$
 (1) $V_{CE} = -1\text{ V}$
 (2) $V_{CE} = -2\text{ V}$
 (3) $V_{CE} = -5\text{ V}$

Fig. 6. DC current gain as a function of collector current; typical values



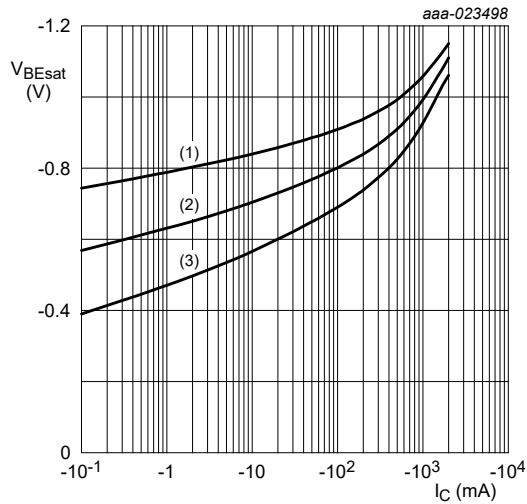
$T_{amb} = 25\text{ }^\circ\text{C}$

Fig. 7. Collector current as a function of collector-emitter voltage; typical values



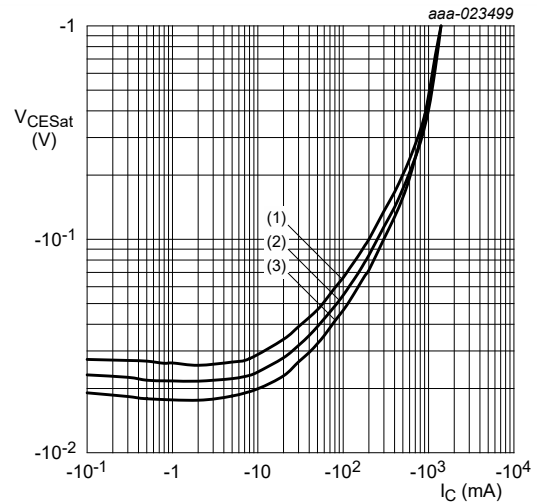
$V_{CE} = -2\text{ V}$
 (1) $T_{amb} = -55\text{ }^\circ\text{C}$
 (2) $T_{amb} = 25\text{ }^\circ\text{C}$
 (3) $T_{amb} = 100\text{ }^\circ\text{C}$

Fig. 8. Base-emitter voltage as a function of collector current; typical values



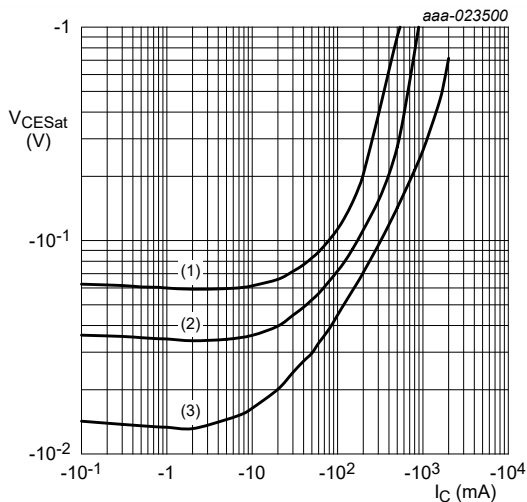
$I_C/I_B = 10$
 (1) $T_{amb} = -55\text{ °C}$
 (2) $T_{amb} = 25\text{ °C}$
 (3) $T_{amb} = 100\text{ °C}$

Fig. 9. Base-emitter saturation voltage as a function of collector current; typical values



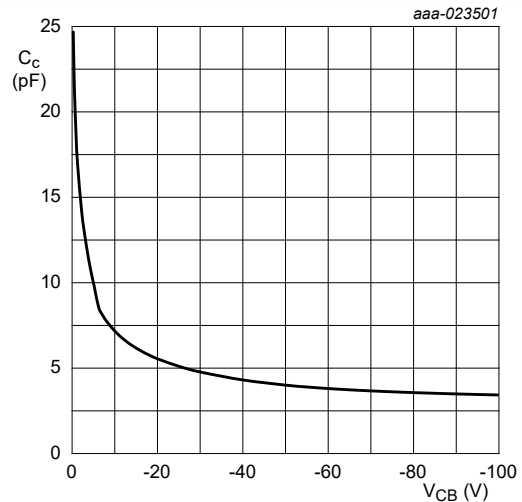
$I_C/I_B = 10$
 (1) $T_{amb} = 100\text{ °C}$
 (2) $T_{amb} = 25\text{ °C}$
 (3) $T_{amb} = -55\text{ °C}$

Fig. 10. Collector-emitter saturation voltage as a function of collector current; typical values



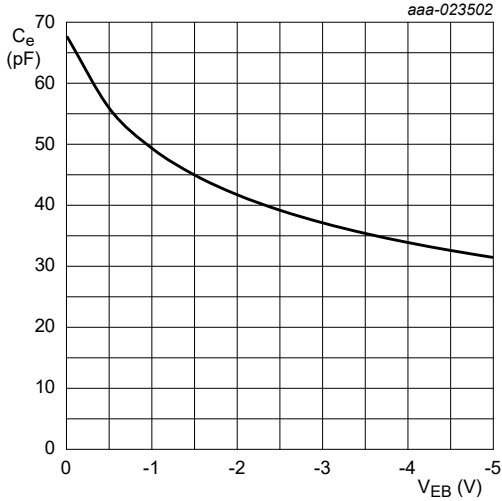
$T_{amb} = 25\text{ °C}$
 (1) $I_C/I_B = 50$
 (2) $I_C/I_B = 20$
 (3) $I_C/I_B = 5$

Fig. 11. Collector-emitter saturation voltage as a function of collector current; typical values



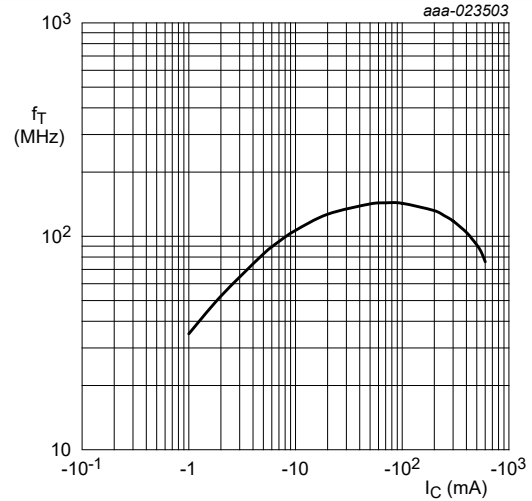
$f = 1\text{ MHz}; T_{amb} = 25\text{ °C}$

Fig. 12. Collector capacitance as a function of collector-base voltage; typical values



$f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}$

Fig. 13. Emitter capacitance as a function of emitter-base voltage; typical values



$V_{CE} = -5 \text{ V}$
 $f = 100 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}$

Fig. 14. Transition frequency as a function of collector current; typical values

8. Test information

8.1. Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

9. Package outline

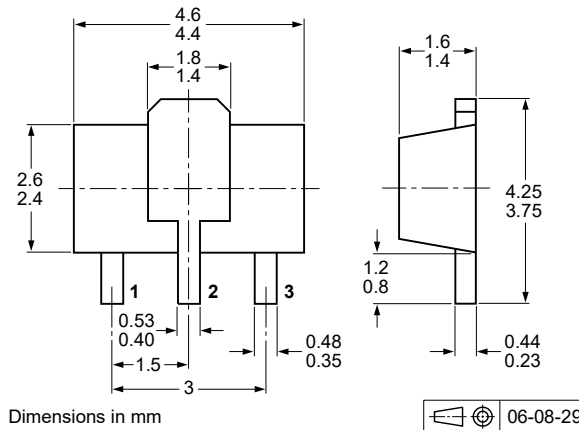
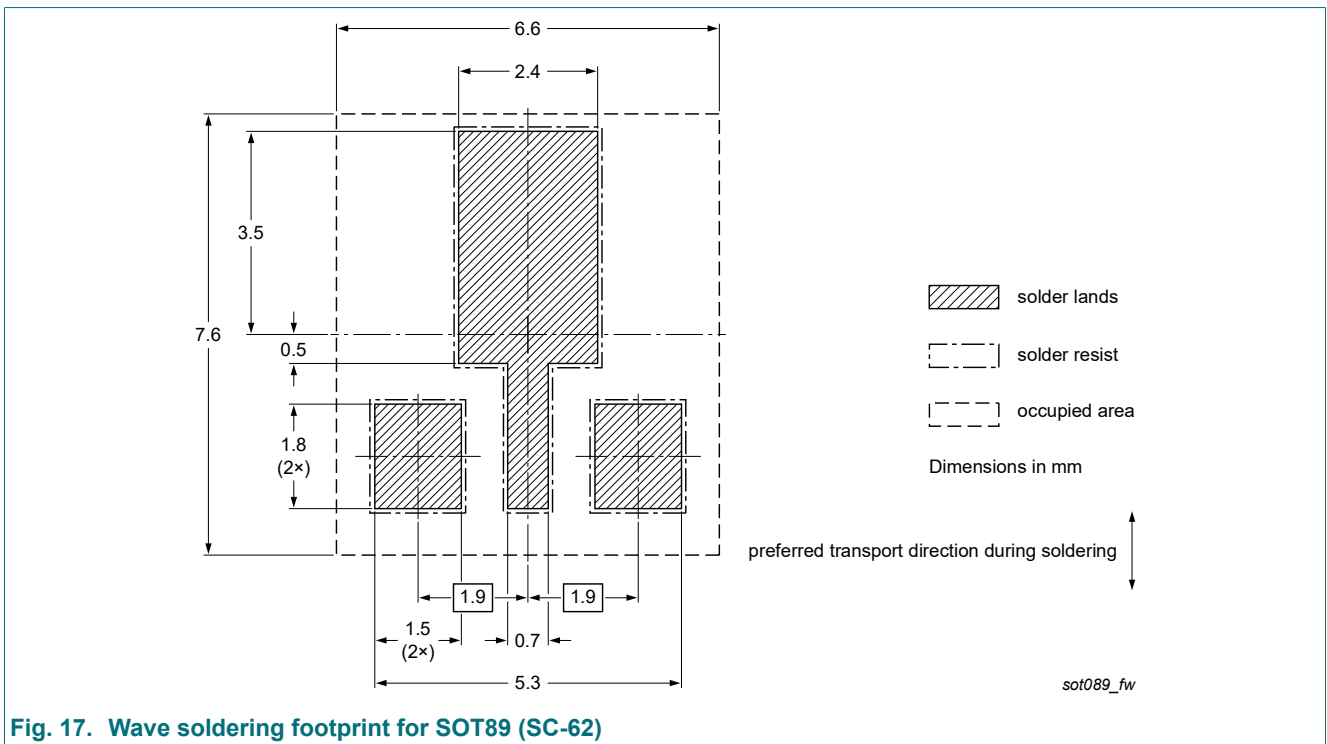
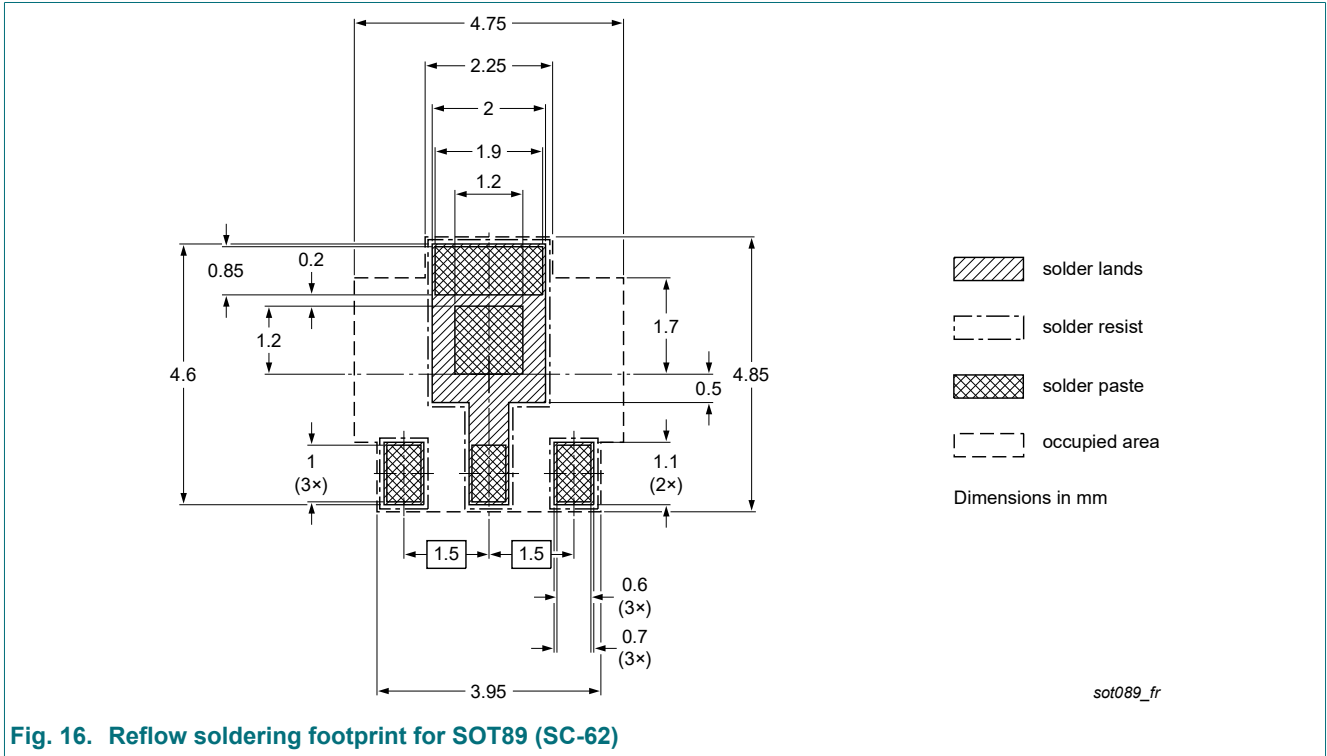


Fig. 15. Package outline SOT89 (SC-62)

10. Soldering



11. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BCX51T_SER v.1	20190822	Product data sheet	-	-

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Contents

1. Product profile	1
1.1. General description.....	1
1.2. Features and benefits.....	1
1.3. Applications.....	1
1.4. Quick reference data.....	1
2. Pinning information	2
3. Ordering information	2
4. Marking	2
5. Limiting values	3
6. Thermal characteristics	4
7. Characteristics	5
8. Test information	8
8.1. Quality information.....	8
9. Package outline	8
10. Soldering	9
11. Revision history	10
12. Legal information	11

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